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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/595,640	05/02/2006	Toshihide Tsubata	70404.90/ma	3891
54072 7590 07/26/2007 SHARP KABUSHIKI KAISHA C/O KEATING & BENNETT, LLP 8180 GREENSBORO DRIVE SUITE 850 MCLEAN, VA 22102			EXAMINER TAYLOR, EARL N	
			ART UNIT 2818	PAPER NUMBER
			NOTIFICATION DATE 07/26/2007	DELIVERY MODE ELECTRONIC

**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

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<b>Office Action Summary</b>	<b>Application No.</b> 10/595,640	<b>Applicant(s)</b> TSUBATA ET AL.	
	<b>Examiner</b> Earl N. Taylor	<b>Art Unit</b> 2818	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

#### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

#### Status

- 1) ☒ Responsive to communication(s) filed on 2 May 2006 to 13 July 2007.
- 2a) ☐ This action is **FINAL**.                      2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

#### Disposition of Claims

- 4) ☒ Claim(s) 1-8 is/are pending in the application.
- 4a) Of the above claim(s) 6 and 7 is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-5 and 8 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

#### Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

#### Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All    b) ☐ Some \*    c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
  2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  3. ☒ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

#### Attachment(s)

- |  |   |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892)  | 4) <input type="checkbox"/> Interview Summary (PTO-413)<br>Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)   | 5) <input type="checkbox"/> Notice of Informal Patent Application                       |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)<br>Paper No(s)/Mail Date <u>5/2/2006, 10/3/2006</u> . | 6) <input type="checkbox"/> Other: _____  |

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## **DETAILED ACTION**

### ***Election/Restrictions***

Applicant's election without traverse of Group I, claims 1-5 and 8, in the reply filed on 13 July 2007 is acknowledged.

### ***Priority***

Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

### ***Information Disclosure Statement***

This office acknowledges receipt of the following items from the applicant: Information Disclosure Statements (IDS) filed on 2 May 2006 and 3 October 2006. The references cited on the PTOL 1449 form have been considered.

### ***Claim Rejections - 35 USC § 102***

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

**Claims 1-5 and 8 are rejected under 35 U.S.C. 102(b) as being anticipated by Shimizu (U.S. Patent 5,834,345).**

Referring to Claims 1 and 2, Shimizu teaches, in Fig. 1 for example, a transistor comprising: a source electrode and a drain electrode (7 and 8); arranged in mutually opposing relation; a semiconductor film comprising at least one layer (5) disposed between the source electrode and the drain electrode (7 and 8); a gate electrode (2) disposed in adjacent relation to the semiconductor film (5); and a gate insulating film (3) disposed between the gate electrode (2) and each of the source electrode, the drain electrode, (7 and 8) and the semiconductor film (5), wherein the gate insulating film (3) does not contain a concentration of fluorine, meaning the concentration of fluorine is zero, which anticipates the range of  $1 \times 10^{20}$  atoms/cm<sup>3</sup> or less and the range of  $1 \times 10^{19}$  atoms/cm<sup>3</sup> or less (Col. 3, Lines 55 to Col. 4, Line 7).

Referring to Claim 3, Shimizu teaches all of the limitations of Claim 1, which is of a field-effect type (Col. 1, Lines 6-10).

Referring to Claim 4, Shimizu teaches all of the limitations of Claim 1, wherein the gate insulating film is an amorphous silicon nitride film (Col. 3, Lines 55-65).

Referring to Claim 5, Shimizu teaches all of the limitations of Claim 1, wherein the gate insulating film is deposited by a CVD method (Col. 3, Lines 55-65).

Furthermore, The language, term, or phrase "the gate insulating film is deposited by a CVD method", is directed towards the process of depositing a film. It is well settled that "product by process" limitations in claims drawn to structure are directed to the product, *per se*, no matter how actually made. *In re Hirao*, 190 USPQ 15 at 17 (footnote 3). See

also, *In re Brown*, 173 USPQ 685; *In re Luck*, 177 USPQ 523; *In re Fessmann*, 180 USPQ 324; *In re Avery*, 186 USPQ 161; *In re Wethheim*, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); *In re Marosi et al.*, 218 USPQ 289; and particularly *In re Thorpe*, 227 USPQ 964, all of which make it clear that it is the patentability of the final product *per se* which must be determined in a "product by process" claim, and not the patentability of the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in "product by process" claims or otherwise. The above case law further makes clear that applicant has the burden of showing that the method language necessarily produces a structural difference.

As such, the claim language only requires a gate insulating film, which does not distinguish the invention from Yamazaki, who teaches the structure as claimed.

Referring to Claim 8, Shimizu teaches all of the limitations of Claim 1 wherein a liquid crystal display device comprising the transistor of claim 1 as a switching element for a pixel electrode portion (Col. 1, Lines 6-10).

**Claims 1-3 and 5 are rejected under 35 U.S.C. 102(b) as being anticipated by Yamazaki et al. (U.S. Patent 5,837,614).**

Referring to Claims 1 and 2, Yamazaki teaches, in Fig. 2 for example, a transistor comprising: a source electrode and a drain electrode (source/drain, 212 and 213); arranged in mutually opposing relation; a semiconductor film (203) comprising at least one layer (208) disposed between the source electrode and the drain electrode (212 and 213); a gate electrode (205) disposed in adjacent relation to the

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semiconductor film (203); and a gate insulating film (204) disposed between the gate electrode (205) and each of the source electrode, the drain electrode, <sup>212 and 213</sup> (208 and 207) <sup>17</sup> and the semiconductor film (208), wherein a concentration of fluorine contained in the gate insulating film (204) is  $1 \times 10^{17}$  atoms/cm<sup>3</sup> to  $5 \times 10^{20}$  atoms/cm<sup>3</sup>, which anticipates the range of  $1 \times 10^{20}$  atoms/cm<sup>3</sup> or less and the range of  $1 \times 10^{19}$  atoms/cm<sup>3</sup> or less (Col. 2, Lines 13-18 and Col. 3, Lines 18-21).

Referring to Claim 3, Yamazaki teaches all of the limitations of Claim 1, which is of a field-effect type.

Referring to Claim 5, Yamazaki teaches all of the limitations of Claim 1, wherein the gate insulating film is deposited by a CVD method (abstract; Col. 4, Lines, 48-59). Furthermore, The language, term, or phrase "the gate insulating film is deposited by a CVD method", is directed towards the process of depositing a film. It is well settled that "product by process" limitations in claims drawn to structure are directed to the product, *per se*, no matter how actually made. *In re Hirao*, 190 USPQ 15 at 17 (footnote 3). See also, *In re Brown*, 173 USPQ 685; *In re Luck*, 177 USPQ 523; *In re Fessmann*, 180 USPQ 324; *In re Avery*, 186 USPQ 161; *In re Wethheim*, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); *In re Marosi et al.*, 218 USPQ 289; and particularly *In re Thorpe*, 227 USPQ 964, all of which make it clear that it is the patentability of the final product *per se* which must be determined in a "product by process" claim, and not the patentability of the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in "product by process" claims

or otherwise. The above case law further makes clear that applicant has the burden of showing that the method language necessarily produces a structural difference.

As such, the claim language only requires a gate insulating film, which does not distinguish the invention from Yamazaki, who teaches the structure as claimed.

### ***Claim Rejections - 35 USC § 103***

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

**Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Yamazaki et al. (U.S. Patent 5,837,614) in view of Ohta et al. (Ultrathin fluorinated silicon nitride gate dielectric films formed by remote plasma enhanced chemical vapor deposition employing NH<sub>3</sub> and SiF<sub>4</sub>).**

Referring to Claim 4, Yamazaki teaches all of the limitations of Claim 1, wherein the gate insulating film is an amorphous silicon nitride film. However, Ohta teaches having a gate insulating film comprising fluorinated silicon nitride by CVD. Therefore it would have been obvious to one having ordinary skill in the art to provide the silicon nitride film of Ohta as the gate insulating film instead of the silicon oxide film of Yamazaki in order to increase the dielectric constant and provide a device low leakage current (abstract).

### ***Conclusion***

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

The following references teach amorphous silicon nitride as a gate insulating layer:

- Hong et al. (U.S. Patent 7,220,991 B2) (Col. 13, Line 21; Col. 30, Lines 9-12).
- Choi et al. (U.S. Patent 7,095,460 B2) (Col. 16, Lines 55-60).
- Inaba et al. (U.S. Patent 4,838,652) Fig. 9
- Mizutani et al. (U.S. Patent 5,812,284)

### ***Telephone / Fax Information***

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Earl N. Taylor whose telephone number is (571) 272-8894. The examiner can normally be reached on Monday-Friday from 8:30AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Steven Loke can be reached on (571) 272-1657. The fax phone number for the organization where this application or proceeding is assigned is (571) 273-8300.



Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Examiner: Earl N. Taylor

STEVEN LOKE  
SUPERVISORY PATENT EXAMINER

A handwritten signature in black ink, appearing to read "Steven Loke", written in a cursive style.